



### SURFACE-MOUNT FAST SWITCHING DIODE

### **Features**

- Fast Switching Speed
- Surface-Mount Package Ideally Suited for Automated Insertion
- For General-Purpose Switching Applications
- High Conductance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The BAS20Q and BAS21Q are suitable for automotive applications requiring specific change control; these parts are AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

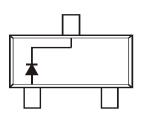
https://www.diodes.com/quality/product-definitions/

## **Mechanical Data**

- Package: SOT23
- Package Material: Molded Plastic.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208.
   Lead-Free Plating (Matte Tin Finish Annealed over Alloy 42
   Leadframe) (a3)
- Polarity: See Diagram
- Weight: 0.008 grams (Approximate)







Top View Internal Schematic

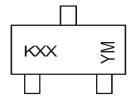
## Ordering Information (Note 4)

Orderable Part Number	Dooksas	Pac	Packing		
Orderable Part Number	Package	Qty.	Carrier		
BAS19-7-F	SOT23	3,000	Tape & Reel		
BAS20-7-F	SOT23	3,000	Tape & Reel		
BAS20-13-F	SOT23	10,000	Tape & Reel		
BAS20Q-13-F	SOT23	10,000	Tape & Reel		
BAS21-7-F	SOT23	3,000	Tape & Reel		
BAS21Q-7-F	SOT23	3,000	Tape & Reel		
BAS21-13-F	SOT23	10,000	Tape & Reel		
BAS21Q-13-F	SOT23	10,000	Tape & Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



KXX = Product Type Marking Code BAS19 Marking: KA8, KT3; T3, KT2 BAS20 Marking: KT2, KT3, T3 BAS21 Marking: KT3, T3

YM = Date Code Marking

A Bar around the Date Code Marking Denotes Assembly Site

Y = Year (ex: L = 2024) M = Month (ex: 9 = September)

Date Code Key

Year	2000	•	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	L	•	L	М	N	Р	R	S	Т	U	V	W
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



### **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Characteristic			BAS19	BAS20	BAS21	Unit
Repetitive Peak Reverse Voltage			120	200	250	V
Working Peak Reverse Voltage DC Blocking Voltage			100	150	200	<b>&gt;</b>
RMS Reverse Voltage	VR(RMS)	71	106	141	V	
Forward Continuous Current (Note 5)	Iғм	400			mA	
Average Rectified Output Current (Note 5)	lo	200			mA	
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs @ t = 1.0ps		IFSM	2.5 0.5			Α
Repetitive Peak Forward Surge Current (Note 5)	IFRM	625			mA	

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance Junction to Ambient Air (Note 5)	RθJA	500	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

## Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

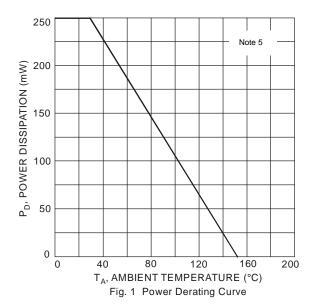
Characteristic	Symbol	Min	Max	Unit	Test Condition	
Reverse Breakdown Voltage (Note 6)	BAS19 BAS20 BAS21	V(BR)R	120 200 250	_	V	I <sub>R</sub> = 100μA
Forward Voltage		VF		1.0 1.25	l V	IF = 100mA IF = 200mA
Reverse Current @ Rated DC Blocking Voltage (Note 6)	IR	_	100 15		$T_J = +25^{\circ}C$ $T_J = +100^{\circ}C$	
Total Capacitance		Ст		5.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time		t <sub>rr</sub>		50	ns ns	$\begin{split} I_F &= I_R = 30 mA, \\ I_{rr} &= 0.1 \text{ x } I_R,  R_L = 100 \Omega \end{split}$

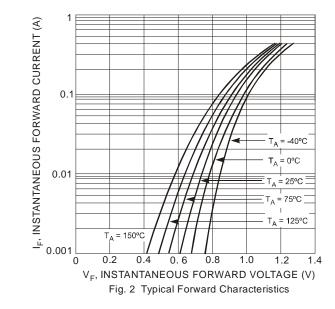
Notes: 5. Part mounted on FR-4 board with one inch square, 2oz copper pad layout. I<sub>FM.</sub> I<sub>O</sub> are valid provided that terminals are kept at ambient temperature.

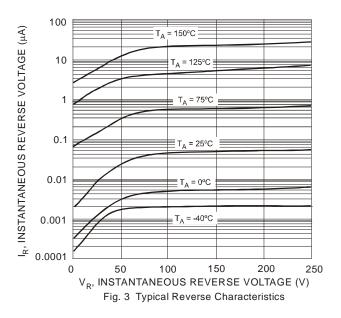
<sup>6.</sup> Short duration pulse test used to minimize self-heating effect.

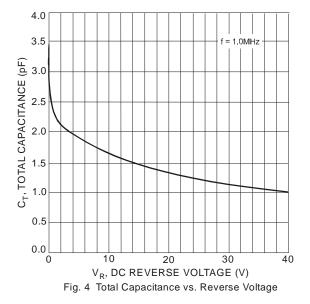








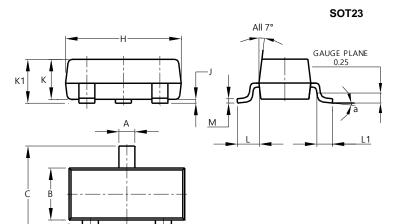






# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

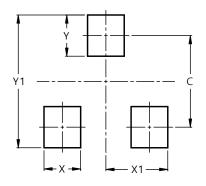


SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
H	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
١	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
М	0.085	0.150	0.110				
а	0°	8°					
All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT23



Dimensions	Value (in mm)
C	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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